

PRELIMINARY AMENDMENT

Serial Number: Unknown

Filing Date: Herewith

Title: METHOD FOR ATTACHING A SEMICONDUCTOR DIE TO A SUBSTRATE

Page 2

Dkt: 303.527US2

The Applicant respectfully requests that the preliminary amendment described herein be entered into the record prior to examination and consideration of the above-identified application.

Respectfully submitted,

EDWARD A. SCHROCK ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

P.O. Box 2938

Minneapolis, MN 55402

(612) 359-3276

Date Aug. 29, 2000

By 

Catherine I. Klima-Silberg

Reg. No. 40,052

"Express Mail" mailing label number: EL517792744US

Date of Deposit: August 29, 2000

This paper or fee is being deposited on the date indicated above with the United States Postal Service pursuant to 37 CFR 1.10, and is addressed to the Commissioner for Patents, Box Patent Application, Washington, D.C. 20231.

0052400" 4234960